HL5075

Back to Back OVP with Adjustable Current limit

Overview

The HL5075 is a slew-rate controlled, low Rdson, over-voltage protection device. It is used in between a power source and a load to protect and isolate power source against unwanted abnormal voltage and current condition. Especially, in the OTG mode of smartphone, the HL5075 could be placed between OTG boost regulator and USB port. The HL5075 can protect boost regulator in smartphone from the USB fault conditions like over-voltage or over-current.

In order to be used at high voltage application (9V or above), the HL5075 apply a high voltage device power FET switch which allows a maximum input voltage of 13.5V. The overvoltage protection threshold is set to 14.2V in HL5075WL01, 10.4V in HL5075WL02, 5.8V in HL5075WL03 and 11.5V in HL5075WL04.

To prevent excessive input voltage or battery droop resulting from a large inrush current, the HL5075 also implements several protection functions, such as over-current protection with FLTB flag, input under-voltage protection, reverse-current protection and over-temperature protection.

HL5075 is available in a 9-pin WLCSP package.

Features

• Input Voltage Range:

HL5075WL01: 2.5V ~ 13.5V

HL5075WL02: 2.5V ~ 10V

o HL5075WL03: 2.5V ~ 5.5V

HL5075WL04: 2.5V ~ 11V

28V Absolute Maximum Voltage Rating of VOUT

Adjustable Current Limit with external resistor

Integrated Power FET switch with 53mΩ Rds(on)
@ 5V/1A

• Built in Soft Start to prevent inrush current

Protection

Over Temperature Protection (OTP)

Over Voltage Protection (OVP):

HL5075WL01: 14.2V

HL5075WL02: 10.4V

HL5075WL03: 5.8V

HL5075WL04: 11.5V

o Over Current Protection

o Reverse Current Protection

Compliance to IEC61000-4-2 on VOUT

Contact discharge: ±8kV

Air Gap discharge: ±15kV

1.2V IO compatible – EN, FLTB

Package:

9-Bump WLCSP, 0.4mm Pitch,1.22mm x 1.22mm

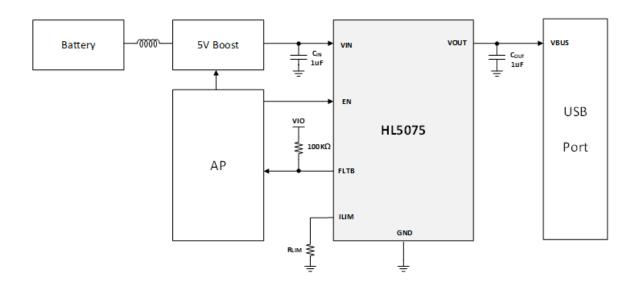
Applications

- Smartphones
- Tablet PC
- Note PC

• Mobile IoT Devices

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Typical Application Diagram



Ordering Information

Part Number	VOUT OVP threshold	Package	Packing Method
HL5075WL01	14.2V	WLCSP-9	Tape & Reel
HL5075WL02	10.4V	WLCSP-9	Tape & Reel
HL5075WL03	5.8V	WLCSP-9	Tape & Reel
HL5075WL04	11.5V	WLCSP-9	Tape & Reel

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